

THE HONG KONG INSTITUTION OF BENITHERS HKIE HI-TECH FIESTA 2014

THE HKIE JOINT INSTITUTES COMPETITION

HIGH GEAR FOR NEW TECHNOLOGY A MINDSET FOR CHANGE

Theme

Participating teams should propose a feasible high technology idea or solution in any engineering discipline, in order to eliminate an existing problem or improve our quality of living.

Eligibility

All Student Members of the HKIE are eligible to participate in the competition free of charge. Contestants should form a team of 3 to 5 members. Students are encouraged to form a team composing of different disciplines. Each student can only participate in one team.

HKIE membership application form is available on the HKIE webpage:

http://www.hkie.org.hk/docs/downloads/ membership/forms/FORM1S.pdf

Competition Format

Contestants should develop innovative ideas and engineering solutions using high technology in any engineering discipline. The competition comprises the heat and the final rounds.

Awards

Cash prizes will be awarded up to 9 teams.

Gold Award **HKD \$30,000** Silver Award **HKD \$20,000 Bronze Award HKD \$10,000**

HKD \$5000 (for each team) Merits (max. 5 teams)

"My Favourite Project" HKD \$5000

Award

http://ymc.hkie.org.hk

Application form and more details of the Competition are available on the HKIE-YMC website!

Organised by:

The Hong Kong Institution of Engineers (HKIE) The HKIE - Young Members Committee

Supported by:

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The HKIE Student Chapter - City University of Hong Kong
The HKIE Student Chapter - Hong Kong Institute of Vocational Education (Chai Wan)
The HKIE Student Chapter - Hong Kong Institute of Vocational Education (Sha Tin)
The HKIE Student Chapter - Hong Kong Institute of Vocational Education (Tsing Yi)
The HKIE Student Chapter - The Chinese University of Hong Kong
The HKIE Student Chapter - The Hong Kong Polytechnic University
The HKIE Student Chapter - The Hong Kong University of Science and Technology
The HKIE Student Chapter - The University of Hong Kong
The HKIE Student Chapter - The University of Hong Kong

Complete & submit your application form and proposal to 'hkie.jic.2013@gmail.com' on or before:

15 FEBRUARY 2014 (SAT)

